October 30, 2025

## Notice of the Completion of the Kumamoto Factory in Japan for Precision Regenerative Cleaning of Semiconductor Manufacturing Equipment Parts

Ferrotec Corporation (Headquartered in Chuo-ku, Tokyo; Representative Director: He Xian Han; hereinafter "Ferrotec") proceeded with the construction of the "Kumamoto Factory" in Ozu Town, Kikuchi District, Kumamoto Prefecture as one of Japan's largest bases for cleaning and recycling precision parts of manufacturing equipment for semiconductor factories, and held a completion ceremony while inviting the officials of local governments, client enterprises, cooperative enterprises, etc. on October 29, 2025.

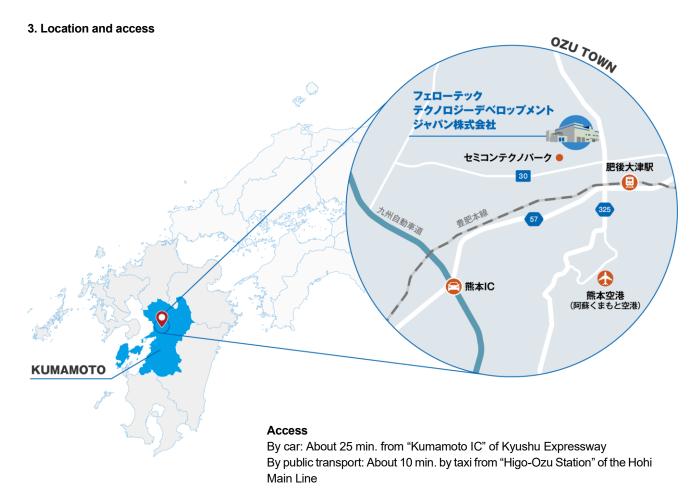
## 1. Outline of the new factory



(1)	Factory name	Ferrotec (Japan) Technology Development Co., Ltd. Kumamoto Factory
(2)	Address	2985-1 Ichinosako, Sugimizu, Ozu Town, Kikuchi District, Kumamoto Prefecture 869-1236
(3)	Products to be manufactured	Recycling of semiconductor manufacturing equipment and its parts, cleaning and recycling of precision parts of semiconductor manufacturing equipment, etc.
(4)	Factory area	Building area: 13,000 m <sup>2</sup> , (site area: 30,000 m <sup>2</sup> )
(5)	Major equipment	Equipment for cleaning and recycling the parts of PVD, CVD, and etching equipment, plasma spraying equipment, arc spraying equipment, ultrasonic microscopes, and three-dimensional measurement devices (cleanroom class: 100)
(6)	No. of employees	56 (It is assumed that there will be around 200 employees in 2028.)

## 2. What is the service of cleaning and recycling precision parts for semiconductor factories?

- •The service of cleaning and recycling precision parts means the service of removing dirt adhering to detachable parts and materials of semiconductor manufacturing equipment, repairing and recycling them.
- •The reason for the inclusion of "precision" is as follows:
  - -The processes of manufacturing semiconductors, especially the front-end processes for forming electronic circuits, include various processes, including film formation, thermal treatment, exposure, etching, and chemical treatment. In addition, cleaning methods vary among product categories, such as logic and memory.
  - -Furthermore, as the miniaturization of semiconductor circuits progresses, it becomes more difficult to remove dirt from them. In addition, an appropriate cleaning method varies among manufacturing equipment makers, so the needs and technologies for cleaning diversify and are individualized.
  - -Ferrotec can clean parts at the level of single-digit nanometers.
- •The reason for the inclusion of "recycling" is as follows:
  - -Under the harsh manufacturing environment, the coating materials of parts are worn away or damaged in some cases.
  - -Our manufacturing facility is also equipped with coating equipment, such as plasma and arc spraying machines, so that we can repair and recycle the materials entrusted by clients.
  - -Our corporate group also produces materials for semiconductor manufacturing equipment (quartz, ceramics, silicon, and CVD-SiC), and solves all kinds of trouble regarding the supply and processing of materials, etc.



[For reference: Scene of the completion ceremony]





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